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At present, high-speed steels are soldered with GPF and GPK solders. The composition of these solders is given in the following table:

Name of Solder	Composition of Elements, in %					Melting point (degrees centigrade)	
	Copper	Nickel	Iron	Manganese	Ceramics		
GFF	66-72	10-14	12-14	4.2-5.0	1.0-1.8	--	1,180-1,280
GFK	74	4.0	6.0	4.5	4.0	7.5	1,150

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The melting point of GPF solder can be changed by changing the percentage of the different elements.

In special cases, welding powders are used for soldering high-speed steel blades. They are composed of ferromanganese, ferrosilicon, or mixtures of them. Frequently, fluxes such as ground glass and borax are added to their composition:

Composition of Welding Powders, in %

<u>Ferro-manganese</u>	<u>Ferro-silicon</u>	<u>Steel Chips</u>	<u>Iron Chips</u>	<u>Copper Chips</u>	<u>Ground Glass</u>	<u>Dehydrated Borax</u>	<u>Commercial Soda</u>	<u>Melting Point, (degrees centigrade)</u>
50	--	--	--	--	30	10	--	1,300-1,320
80	--	--	--	20	--	--	--	1,160-1,180
75	--	--	--	25	--	--	--	1,160-1,180
--	32	10	--	16	--	32	10	1,250-1,280
40	10	--	20	5	15	10	--	1,190-1,300

The effectiveness of these powders differs little from that of solders. However, since they have less flowability as compared with ordinary solders, they have little resistance to bending stresses. For this reason, they are used for the most part on single-blade tools.

Hard metal-ceramic (powder-metallurgy) alloys do not require any heat treatment and can, without detriment to the cutting properties, be heated during soldering to 1,100-1,150 degrees centigrade. Only in heating special titanium-carbide alloys to very high temperatures can fractures occur.

The basic requirements for solder for hard alloys are as follows:

1. The solder must have a melting temperature of from 900 to 1,100 degrees centigrade.
2. In addition to high mechanical strength, the solder must have high plastic properties.

Among the solders used for soldering hard alloys, the best are copper-nickel alloys, electrolytic copper, brasses with nickel added, and pure brasses. The composition of these solders is shown in the following table.

Composition, in %

<u>Name of Solder</u>	<u>Copper</u>	<u>Nickel</u>	<u>Zinc</u>	<u>Lead</u>	<u>Manganese</u>	<u>Aluminum</u>	<u>Melting Temperature, (degrees centigrade)</u>
Copper-nickel-zinc	66-68	26-28	3.0	--	--	0.8-1.0	1,100-1,150
Copper-nickel-zinc	85-87	8-10	3.0	--	--	0.8-2.0	1,020
VNIIS	90	3	--	--	2	5	1,100-1,150
KM	58-60	8-9	3.0-3.2	1-2	--	--	950-980

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Composition, in %

<u>Name of Solder</u>	<u>Copper</u>	<u>Nickel</u>	<u>Zinc</u>	<u>Lead</u>	<u>Manga- nese</u>	<u>Aluminum</u>	<u>Melting Temperature (degrees centigrade)</u>
PMTs 52 (GOST 1534-42)	49-53	--	47-51	--	--	--	876
PMTs 47 (GOST 1534-42)	45-49	--	51-55	--	--	--	860
Electrolytic copper	99.9	--	--	--	--	--	1,083

The first three solders can be used for all hard alloys in tools operating under a big load. If the hard-alloy blades become fractured in soldering, or in the process of grinding or lapping, it is recommended that KM solder, which has a lower melting point, be used.

For tools operating under a small load (drills up to 15 millimeters in diameter and small cutting tools), solders (PMTs-52 and PMU-47) which have a lower melting point can be used in the form of a foil.

The use of electrolytic copper under conditions of heating without a reducing atmosphere is not recommended because the soldering process takes place at a temperature of 1,120-1,150 degrees centigrade and leads to the intensive oxidation of the solder, thus lowering the strength of the joint.

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